## NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

### **AEC-Q101 Qualified**

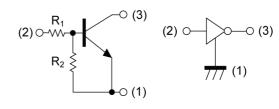
Parameter	Value
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	47kΩ
R <sub>2</sub>	47kΩ

# Outline SOT-323 SC-70 (2) (1) (UMT3)

#### Features

- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 47k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA144EU3 HZG

#### •Inner circuit



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

## Application

INVERTER, INTERFACE, DRIVER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC144EU3 HZG	SOT-323 (UMT3)	2021	T106	180	8	3000	26

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Supply voltage	V <sub>CC</sub>	50	V
Input voltage	V <sub>IN</sub>	-10 to 40	V
Output current	Io	30	mA
Collector current	I <sub>C(MAX)</sub> *1	100	mA
Power dissipation	P <sub>D</sub> *2	200	mW
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

# • Electrical characteristics (T<sub>a</sub> = 25°C)

Davamatav	Cymahal	Canditions	Values			l limit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input voltage	$V_{I(off)}$	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100μA	-	-	0.5	V	
Input voltage	V <sub>I(on)</sub>	$V_O = 0.3V$ , $I_O = 2mA$	3.0	-	1		
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 10mA, I <sub>I</sub> = 0.5mA	-	100	300	mV	
Input current	I <sub>I</sub>	I <sub>I</sub> V <sub>I</sub> = 5V		-	180	μA	
Output current	I <sub>O(off)</sub>	$V_{CC} = 50V, V_{I} = 0V$	-	-	500	nA	
DC current gain	G <sub>I</sub>	$V_{O} = 5V, I_{O} = 5mA$	68	-	-	-	
Input resistance	R <sub>1</sub>	-	32.9	47	61.1	kΩ	
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	0.8	1.0	1.2	-	
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz	

<sup>\*1</sup> Characteristics of built-in transistor

<sup>\*2</sup> Each terminal mounted on a reference land.

INPUT VOLTAGE: V<sub>I(on)</sub> [V]

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

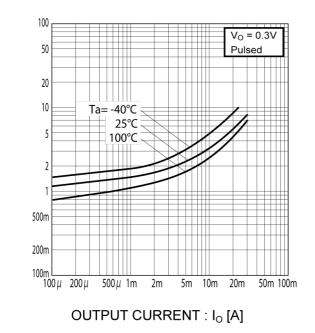
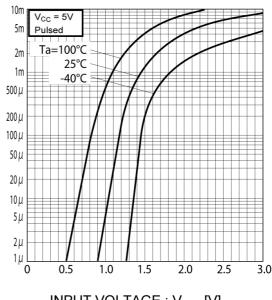


Fig.2 Output current vs. input voltage (OFF characteristics)



OUTPUT CURRENT : I<sub>o</sub> [A]

INPUT VOLTAGE :  $V_{I(off)}$  [V]

Fig.3 Output current vs. output voltage

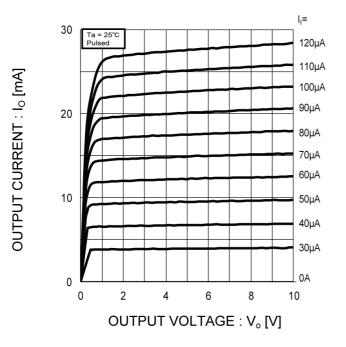
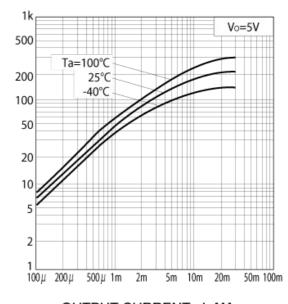


Fig.4 DC current gain vs. output current

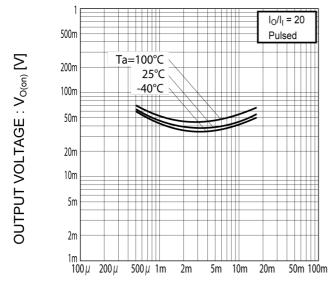


OUTPUT CURRENT: Io [A]

DC CURRENT GAIN: G

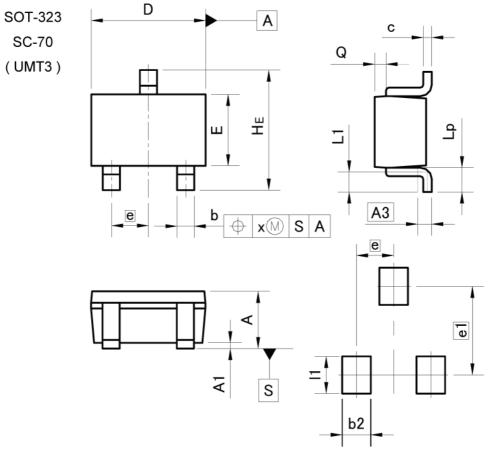
# ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : Io [A]

## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0	0.004	
A3	0.5	25	0.01		
b	0.25	0.40	0.01	0.016	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.0	65	5 0.		
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.02	
Lp	0.25	0.55	0.01	0.022	
Q	0.10	0.30	0.004	0.012	
х	_	0.10	_	0.004	

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
e1	1.	55	0.06		
b2	-	0.50	1	0.02	
11	_	0.65	_	0.026	

Dimension in mm/inches

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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
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- 4. The Products are not subject to radiation-proof design.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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